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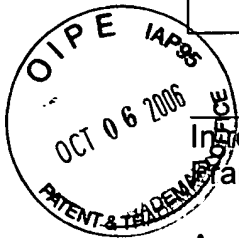
I hereby certify that this paper (along with any paper referred to as being attached or enclosed) is being deposited with the U.S. Postal Service on the date shown below with sufficient postage as First Class Mail, in an envelope addressed to: MS Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Dated: 10/3/06

Signature:

*A. L. Hamm*  
(Amy L. Hamm)

Docket No.: 05587-00364-US  
(PATENT)



**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Patent Application of:  
Frank Reil et al.

Application No.: 10/758,715

Confirmation No.: 6557

Filed: January 16, 2004

Art Unit: 3729

For: PROCESS FOR APPLYING CONDUCTOR  
TRACKS TO THE SURFACE OF PLASTICS  
MOLDINGS, AND THE RESULTANT  
MOLDINGS

Examiner: T. D. Phan

**AMENDMENT IN RESPONSE TO NON-FINAL OFFICE ACTION**

MS Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

**INTRODUCTORY COMMENTS**

In response to the Office Action dated July 6, 2006, please amend the above-identified U.S. patent application as follows:

**Amendments to the Specification** begin on page 2 of this paper.

**Amendments to the Claims** are reflected in the listing of claims which begins on page 3 of this paper.

**Remarks/Arguments** begin on page 6 of this paper.